P30 – precision SMT pick & place machine with dispensing head and dual camera system.





TECHNICAL DATA

PCB

• max. placement area 500 x 480mm

Components range

- from 0201 up to 40 x 80mm
- min. pitch 0,4mm

Components packing

tapes / sticks / trays / bulk comp.

Componets centering

· optical alignment

Placement rate

• up to 1200 cph

· Dispensing rate

• up to 7500 dph

Feeder capacity

 31 x 8mm automatic tape feeder + 40 x 8mm semi tape feeder and 2 x (300 x 200mm) - IC-tray with 200 x 300mm PCB size

Resolution

- X / Y axis 0,008mm linear encoders
- Z axis 0,020mm linear encoder
- Rotation 0,01° rotary encoder

Placement accuracy

• +/- 0,03 mm

Dimension and weight

• 840 x 630 x 430 mm / ca. 95 kg



Visit the website for more info.

KEY FEATURES

- 1 x automatic pick & place head
- 1 x automatic dispensing head
- automatic nozzle changer including 6 tools
- top camera system for automatic fiducial recognition (Board & Component alignment)
- bottom camera optical alignment system for all SMD components
- Full features Graphical software package included
- CAD editor for creating pick & place programs
- Gerber editor for creating dispensing programs
- teach-in / debug mode using the top camera
- image processing software system
- intelligent feeder system CAN Bus
- · operating system: Windows 10
- · control panel: PC keybord / Mouse
- user interface PC and LCD monitor

· application range

- · prototypes and low volume production
- · pick & place of of all types of SMD components

Supply

• 110- 230 V / 50-60 Hz / 1350 W / 0,6 Mpa / 30 l/min

